

# BRIGHTEK OPTOELECTRONICS

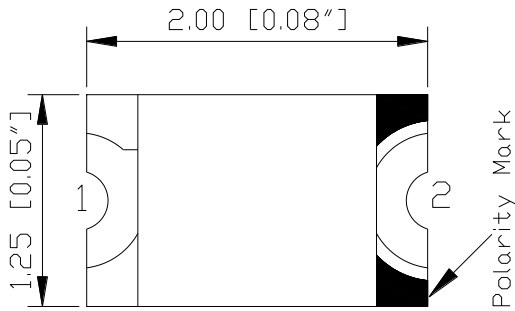
## SURFACE MOUNT LED LAMPS

### S170 Series SMD Chip LED Lamps

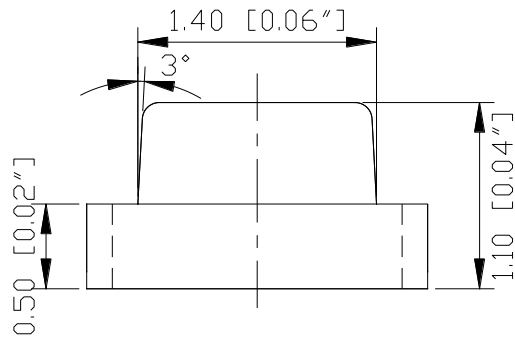
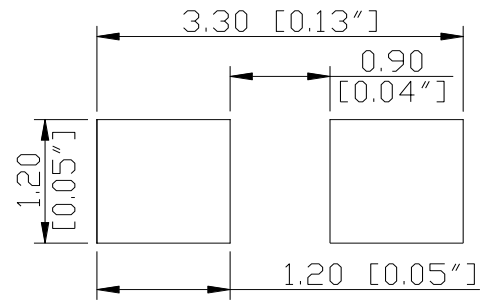
Part NO.:

Code NO.:N0W49S59

### Package outlines

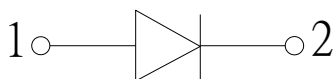
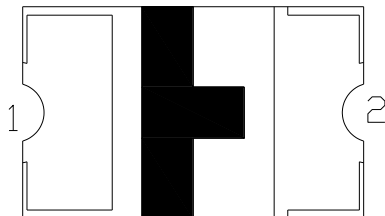


#### RECOMMEND PAD LAYOUT





**ATTENTION**  
OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
SENSITIVE DEVICES



ITEM	MATERIALS
Resin (mold)	Epoxy
Lens color	Yellow
Dice	InGaN
Emitted color	White

#### NOTES:

1. All dimensions are in millimeters (inches);
2. Tolerances are  $\pm 0.1\text{mm}$  (0.004inch) unless otherwise noted.

Rev :	Date	Drawn by :	Checked by :	Approved by :
A	2019/08/05	唐云	周書蘭	李用基

# BRIGHTEK OPTOELECTRONICS

## SURFACE MOUNT LED LAMPS

Part NO.:

Code NO.: N0W49S59

### Absolute maximum ratings

(T<sub>A</sub>=25°C)

Parameter	Symbol	Value	Unit
Forward current	I <sub>f</sub>	30	mA
Reverse voltage	V <sub>r</sub>	5	V
Power dissipation	P <sub>d</sub>	111	mW
Operating temperature range	T <sub>op</sub>	-40 ~+80	°C
Storage temperature range	T <sub>stg</sub>	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	I <sub>fp</sub>	125	mA

### Electro-optical characteristics

(T<sub>A</sub>=25°C)

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
CIE Coordinates	I <sub>f</sub> =20mA	X	--	0.253	--	--
		Y	--	0.224	--	
Forward voltage	I <sub>f</sub> =20mA	V <sub>f</sub>	2.8	3.1	3.7	V
Luminous intensity	I <sub>f</sub> =20mA	I <sub>v</sub>	100	195	320	mcd
Viewing angle at 50% I <sub>v</sub>	I <sub>f</sub> =10mA	2θ 1/2	--	140	--	Deg
Reverse current	V <sub>r</sub> =5V	I <sub>r</sub>	--	--	10	μA

# BRIGHTEK OPTOELECTRONICS

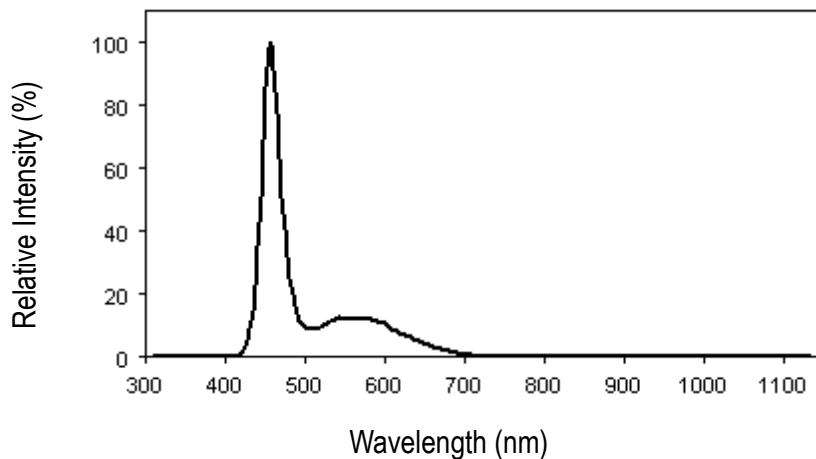
## SURFACE MOUNT LED LAMPS

Part NO.:

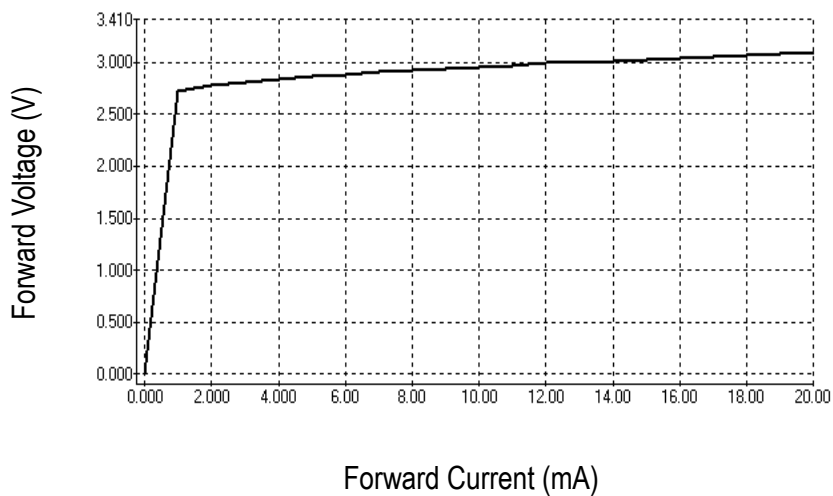
Code NO.: N0W49S59

### OPTICAL CHARACTERISTIC CURVES

Relative Intensity vs. Wavelength

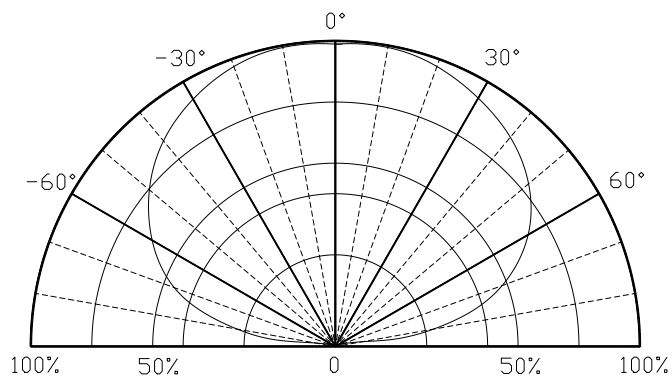


Forward Current vs. Forward Voltage



Forward Current (mA)

Directive Characteristics

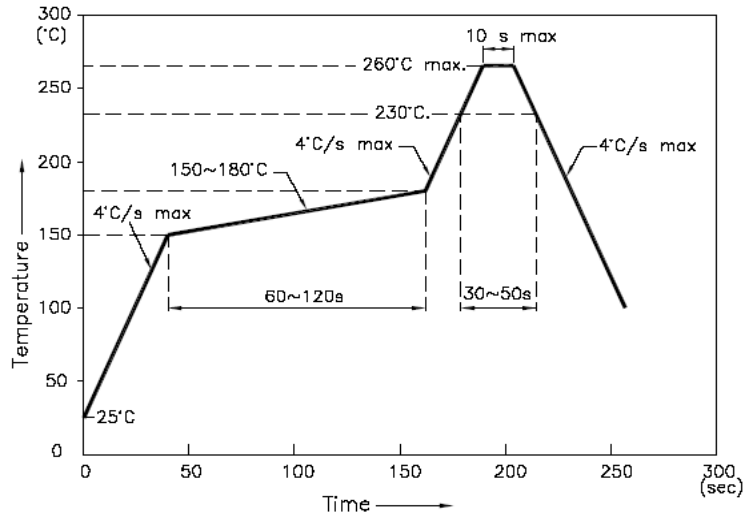


# BRIGHTEK OPTOELECTRONICS

## SURFACE MOUNT LED LAMPS

### Reflow Profile

#### ■ Reflow Temp/Time



#### NOTES:

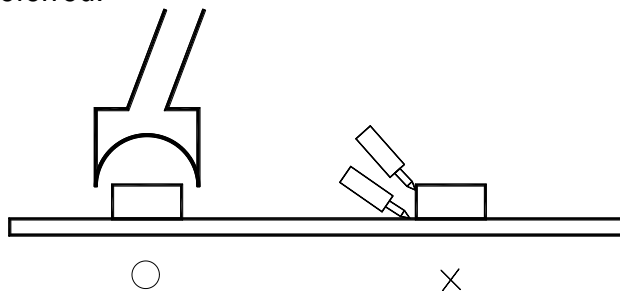
1. We recommend the reflow temperature  $245^{\circ}\text{C} (\pm 5^{\circ}\text{C})$ . the maximum soldering temperature should be limited to  $260^{\circ}\text{C}$ .
2. dont cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

#### ■ Soldering iron

Basic spec is  $\leq 5\text{sec}$  when  $260^{\circ}\text{C}$ . If temperature is higher, time should be shorter ( $+10^{\circ}\text{C} \rightarrow -1\text{sec}$ ). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under  $230^{\circ}\text{C}$ .

#### ■ Rework

1. Customer must finish rework within 5 sec under  $260^{\circ}\text{C}$ .
2. The head of iron can not touch copper foil
3. Twin-head type is preferred.



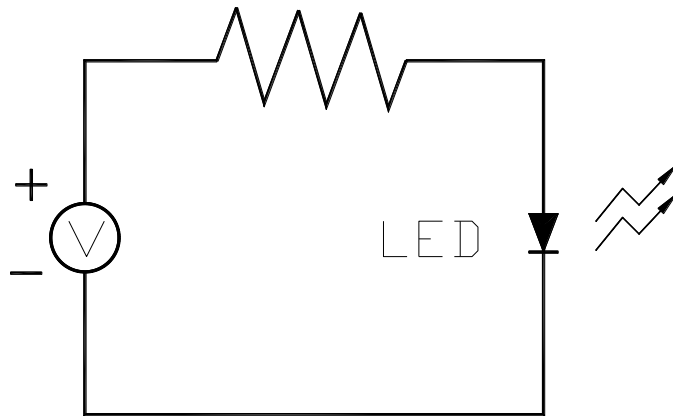
- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow 、 solder etc.

# BRIGHTEK OPTOELECTRONICS

## SURFACE MOUNT LED LAMPS

### Test circuit and handling precautions

#### ■ Test circuit



#### ■ Handling precautions

##### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Shelf life in sealed bag: 12 months at  $5^{\circ}\text{C}\sim 30^{\circ}\text{C}$  and  $< 60\%$  R.H;

3. After the package is Opened:

3.1. It is recommended to baking before the first use:

Baking condition:

a.  $60\pm 5^{\circ}\text{C}$  x (24~48hrs) and  $< 5\%$  RH, taped reel type ;

b.  $110\pm 5^{\circ}\text{C}$  x (8~16hr), bulk type ;

3.2. The products should be used within a week and to be stored at  $\leq 20\%$  R.H. with zip-lock sealed:

a. Baking is required before soldering when the pack is unsealed after 24hrs ;

b. Baking condition as 3.1 baking condition.

# BRIGHTTEK OPTOELECTRONICS

## SURFACE MOUNT LED LAMPS

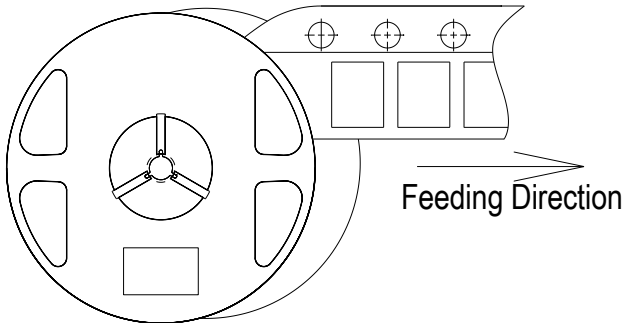
### Test items and results of reliability

Type	Test Item	Test Conditions	Note	Number of Damaged
Environmental Sequence	Temperature Cycle	-20°C 30min ↑ ↓ 80°C 30min	100 cycle	0/22
	Thermal Shock	-20°C 15min ↑ ↓ 80°C 15min	100 cycle	0/22
	High Humidity Heat Cycle	30°C ↔ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
	High Temperature Storage	T <sub>a</sub> =80°C	1000 hrs	0/22
	Humidity Heat Storage	T <sub>a</sub> =60°C RH=90%	1000 hrs	0/22
	Low Temperature Storage	T <sub>a</sub> =-30°C	1000 hrs	0/22
Operation Sequence	Life Test	T <sub>a</sub> =25°C I <sub>F</sub> =20mA	1000 hrs	0/22
	High Humidity Heat Life Test	60°C RH=90% I <sub>F</sub> =10mA	500 hrs	0/22
	Low Temperature Life Test	T <sub>a</sub> =-20°C I <sub>F</sub> =20mA	1000 hrs	0/22

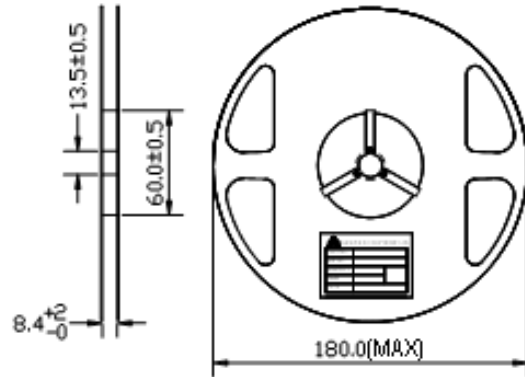
# PACKAGING SPECIFICATIONS

## S170 Series SMD Chip LED Lamps Packaging Specifications

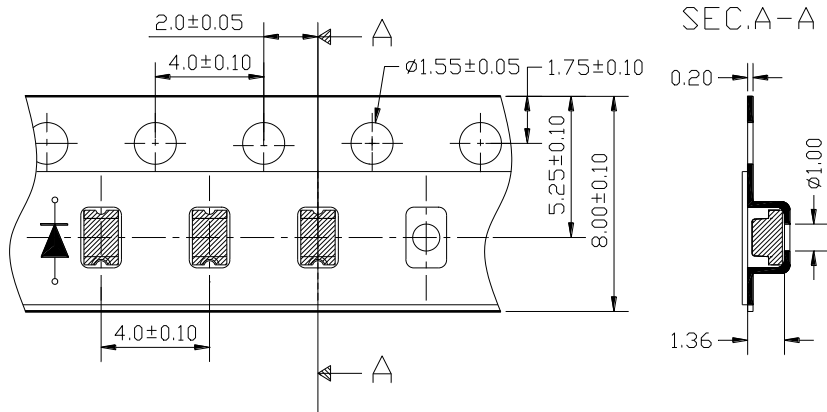
### ● Feeding Direction



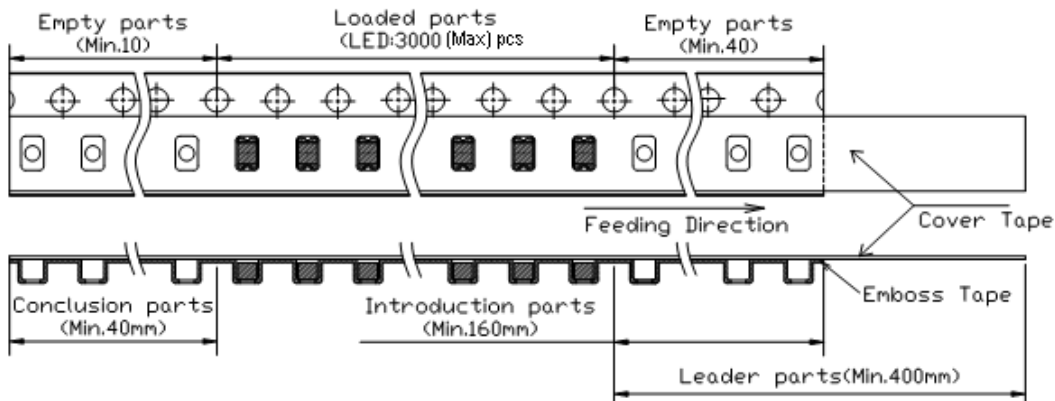
### ● Dimensions of Reel (Unit: mm)



### ● Dimensions of Tape (Unit: mm)



### ● Arrangement of Tape



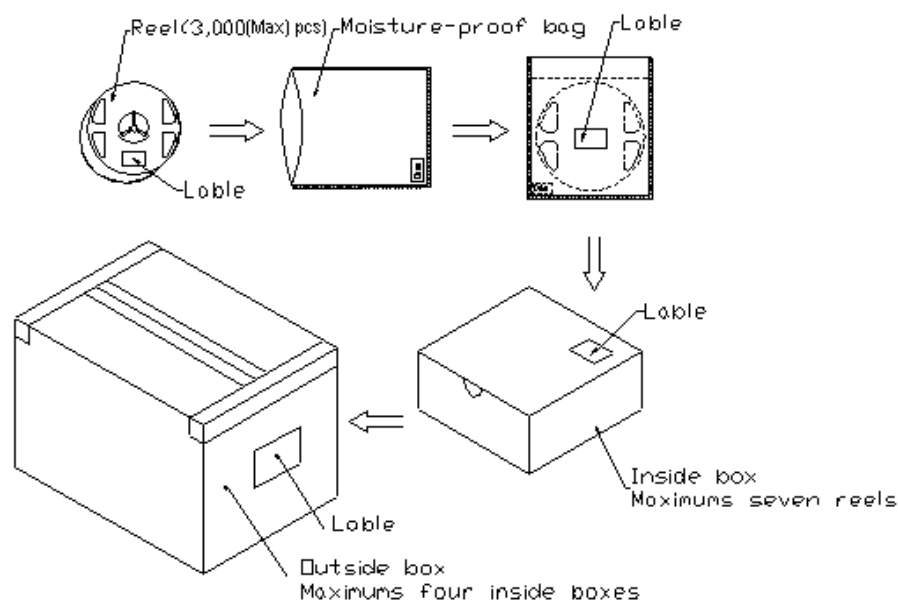
### NOTES

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 3,000(Max)pcs/Reel

# PACKAGING SPECIFICATIONS

## S170 Series SMD Chip LED Lamps Packaging Specifications

- Packaging specifications



### NOTES:

Reeled products [numbers of products are 3,000(Max)pcs] packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums [total maximum number of products are 21,000(Max)pcs] packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.



# BRIGHTEK OPTOELECTRONICS

## SURFACE MOUNT LED LAMPS

Part NO.:

Code NO.: N0W49S59

### Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
f	2.8	3.1	V
g	3.1	3.4	
h	3.4	3.7	

### Luminous Intensity Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
J	100	125	mcd
K	125	160	
L	160	200	
M	200	250	
N	250	320	

### Group Name on Label ( Example DATA: gLB2 20 )

DATA: gLB2 20	Vf(V)	Iv (mcd)	CIE(X,Y)	Test Condition
g→L→B2→20	3.1~3.4	160~200	X(0.243~0.263),Y(0.194~0.254)	IF=20mA

\* NOTE:

1. The tolerance of luminous intensity (Iv) is  $\pm 15\%$  .
2. The tolerance of Chromaticity coordinates is  $\pm 0.02$ .
3. This specification is preliminary.

# BRIGHTEK OPTOELECTRONICS

## SURFACE MOUNT LED LAMPS

Part NO.:

Code NO.: N0W49S59

### Chromaticity coordinates Ranks combination (IF=20mA)

Rank	Chromaticity coordinates				
A1	X	0.223	0.223	0.243	0.243
	Y	0.194	0.224	0.254	0.224
A2	X	0.223	0.223	0.243	0.243
	Y	0.164	0.194	0.224	0.194
A3	X	0.223	0.223	0.243	0.243
	Y	0.134	0.164	0.194	0.164
B1	X	0.243	0.243	0.263	0.263
	Y	0.224	0.254	0.284	0.254
B2	X	0.243	0.243	0.263	0.263
	Y	0.194	0.224	0.254	0.224
B3	X	0.243	0.243	0.263	0.263
	Y	0.164	0.194	0.224	0.194
C1	X	0.263	0.263	0.283	0.283
	Y	0.254	0.284	0.314	0.284
C2	X	0.263	0.263	0.283	0.283
	Y	0.224	0.254	0.284	0.254
C3	X	0.263	0.263	0.283	0.283
	Y	0.194	0.224	0.254	0.224

